



RE913

- Adapter DFN10 & eMSOP10
- Epoxy fibre-glass 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au
- Solder stop mask
- Adaption circuit board for DFN10 & eMSOP10 with 0.50 mm pitch
- Hole spacing 2.54 mm
- Solder pads Ø 2,20 mm
- Shield pad & cooling pad
- Size 12.50 x 12.50 mm